| ASSOCIATION CONNECTING                        | Material Composite<br>© Copyright 2005. IPC,<br>international and Pan-Ar                              | Bannockb                 | urn, Illinois. A          | ll rights reserved nations.      | under both | This docume<br>level parts, t             | ent is a declaration e                         | on of the su | ibstances v<br>s all lower | within the manufact<br>level materials for | urer listed<br>which the            | item. Note:<br>nanufacture      | if the item is an as<br>er has engineering | ssembly with low responsibility. |  |
|---|---|--------------------------|---------------------------|----------------------------------|------------|---|--|--------------|----------------------------|--|-------------------------------------|---------------------------------|--|----------------------------------|--|
| 752-21.1                                      | IPC Web Site for Information on IPC-1752 Standard Form Type<br>http://www.ipc.org/IPC-175x Distribute |                          |                           |                                  | e *        | Class 6 - RoHS Yes/No, Homogeneous Materi |  |              |                            |  | als and Mfg Information             |                                 |  |                                  |  |
| upplier Informa                               | ation   |                          |                           |                                  |            |   |  |              |                            |  |                                     |                                 |  |                                  |  |
| Company name*                                 |   |                          | Company unique ID         |                                  |            |   | Unique ID Authority                            |              |                            |  | Respon                              | Response Date*                  |  |                                  |  |
| onsemi  |   |                          |                           |                                  |            |   |  |              |                            |  | 2023-00                             | 2023-06-08                      |  |                                  |  |
| Contact Name                                  |   |                          | Title - Contact           |                                  |            |   | Phone - Contact*                               |              |                            |  | Email -                             | Email - Contact*                |  |                                  |  |
| Product-Env-Stewards                          |   |                          | Product Enviro Compliance |                                  |            |   | NA   |              |                            |  | Produ                               | Product-Env-Stewards@onsemi.com |  |                                  |  |
| Authorized Representative*                    |   |                          | Title - Representative    |                                  |            |   | Phone - Representative*                        |              |                            |  | Email -                             | Email - Representative*         |  |                                  |  |
| Product-Env-Stewards                          |   |                          | Product Enviro Compliance |                                  |            |   | NA   |              |                            |  | Produ                               | Product-Env-Stewards@onsemi.com |  |                                  |  |
| Requester                                     | Requester Item Number Mfr Item  |                          | n Number Mfr Item Name    |                                  |            |   | Effective Date                                 | Version      | M                          | Manufacturing Site                         |                                     | Weight*                         | UOM  | Unit Type                        |  |
|   |   | FAN53611AUC13X DC/DC 6MH |                           | DC/DC 6MHz B                     | Hz Buck 1A |   | 2023-06-08                                     |              | P                          | PBB  |                                     | 1.25031                         | mg   | Each                             |  |
| Ianufacturing P                               | Proccess Information  | n                        |                           |                                  |            |   |  | _            |                            |  |                                     |                                 |  |                                  |  |
| Terminal Plating / Grid Array Material Termin |   |                          | erminal Base A            | ninal Base Alloy J-STD-020 MSL I |            |   | Peak Process Body Temperature Max Time at Peak |              |                            | ık Tempera                                 | Temperature Number of Reflow Cycles |                                 |  |                                  |  |
| SnAgCu CU                                     |   |                          | CU Alloy 1                |                                  |            |   | 260 C 30                                       |              | seconds 3                  |  |                                     |                                 |  |                                  |  |
| omments                                       |   |                          |                           |                                  |            |   |  |              |                            |  |                                     |                                 |  |                                  |  |
| vel 1 - maximum tir                           | me at peak temperature o  | luring sol               | dering is 10-3            | 0 seconds                        |            |   |  |              |                            |  |                                     |                                 |  |                                  |  |
| or more information                           | n regarding material con  | position                 | please refer to           | page 3                           |            |   |  |              |                            |  |                                     |                                 |  |                                  |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Substance Instructions: [A] select<br>select a RoHS exemption, if applic<br>sigma range of distribution unless | cable [E] enter the weight |                 |          |               |                  |        |        |                 |
|--|----------------------------|-----------------|----------|---------------|------------------|--------|--------|-----------------|
| Homogeneous Material   | Weight                     | Unit of Measure | Level    | Substance     | CAS              | Exempt | Weight | Unit of Measure |
| Die  | 0.873382                   | mg              | Supplier | Silicon (Si)  | 7440-21-3        |        | 0.8734 | mg              |
| Protection coat  | 0.011543                   | mg              |          | Polyimide     | proprietary data |        | 0.0115 | mg              |
| Solder Ball  | 0.36503                    | mg              | Supplier | Silver (Ag)   | 7440-22-4        |        | 0.0146 | mg              |
|  |                            |                 | Supplier | Tin (Sn)      | 7440-31-5        |        | 0.3486 | mg              |
|  |                            |                 | Supplier | Copper (Cu)   | 7440-50-8        |        | 0.0018 | mg              |
| Under Bump Metal   | 3.55E-4                    | mg              | Supplier | Titanium (Ti) | 7440-32-6        |        | 0.0001 | mg              |
|  |                            |                 | Supplier | Copper (Cu)   | 7440-50-8        |        | 0.0003 | mg              |